

2-2-06

Attorney Docket No.: 007685/PMG/EPIC/JW

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Application of: Judon Tony PAN

) Group Art Unit: 2818

) Examiner: Le, Dung Anh

Serial No.: 10/654,240

Confirmation No.: 4883

Filed: 09/02/2003

For: Bond Pad Techniques For Integrated
Circuits) Transmittal letterCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith is an **AMENDMENT AND RESPONSE** in the above-identified application, in response to the Office Action mailed December 8, 2005. The fee has been calculated as shown below.

	(Col.1)		(Col.2)	(Col.3)		
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	9	MINUS	40	0		\$0.00
INDEPENDENT	1	MINUS	11	0		\$0.00
FIRST	PRESENTATION	OF	MULTIPLE DEPENDENT	CLAIM		
TOTAL						\$0.00 . . .

- * If the entry in Col.1 is less than the entry in Col.2, "0" is written in Col.3.
** If the "Highest Number Previously Paid for" IN THIS SPACE is less than 20, "20" is written in this space.
*** If the "Highest Number Previously Paid for" IN THIS SPACE is less than 3, "3" is written in this space.
The "Highest Number Previously Paid For" (Total or Independent is the highest number found from the equivalent box in Col.1 of a prior amendment or the number of claims originally filed.)

X No additional Filing Fee is required.

Please address all correspondence to:

PATENT COUNSEL
APPLIED MATERIALS, INC.
Legal Affairs Department
P.O. Box 450 A
Santa Clara, CA 95052

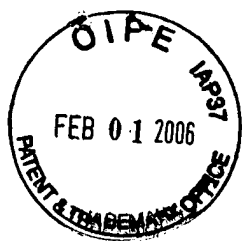
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Date of Deposit Feb.1, 2006Signature: Albert J. Dalhuisen
Albert J. Dalhuisen

Respectfully Submitted,

By: Albert J. DalhuisenAlbert J. Dalhuisen
Registration No.: 36,117Dated: Feb.1, 2006



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:) Group Art Unit: 2818
) Examiner: Le, Dung Anh
Judon Tony PAN)
) <u>Amendment And Response To</u>
Serial No.: 10/654,240) <u>12/08/2005 Office Communication</u>
Confirmation No.: 4883)
Filed: 09/02/2003) PATENT COUNSEL
) APPLIED MATERIALS, INC.
For: Bond Pad Techniques For) Legal Affairs Department
Integrated Circuits) P.O. Box 450 A
) Santa Clara, CA 95052

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Response

This response concerning the above-identified patent application is in response to the Office Communication mailed on December 8, 2005.